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(54) **LOGIC MODULE REFRIGERATION
SYSTEM WITH CONDENSATION CONTROL**

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Related U.S. Application Data

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2001, now Pat. No. 6,446,447.

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(52) **U.S. Cl.** **62/259.2**; 62/407

(58) **Field of Search** 62/259.2, 176.1,
62/407

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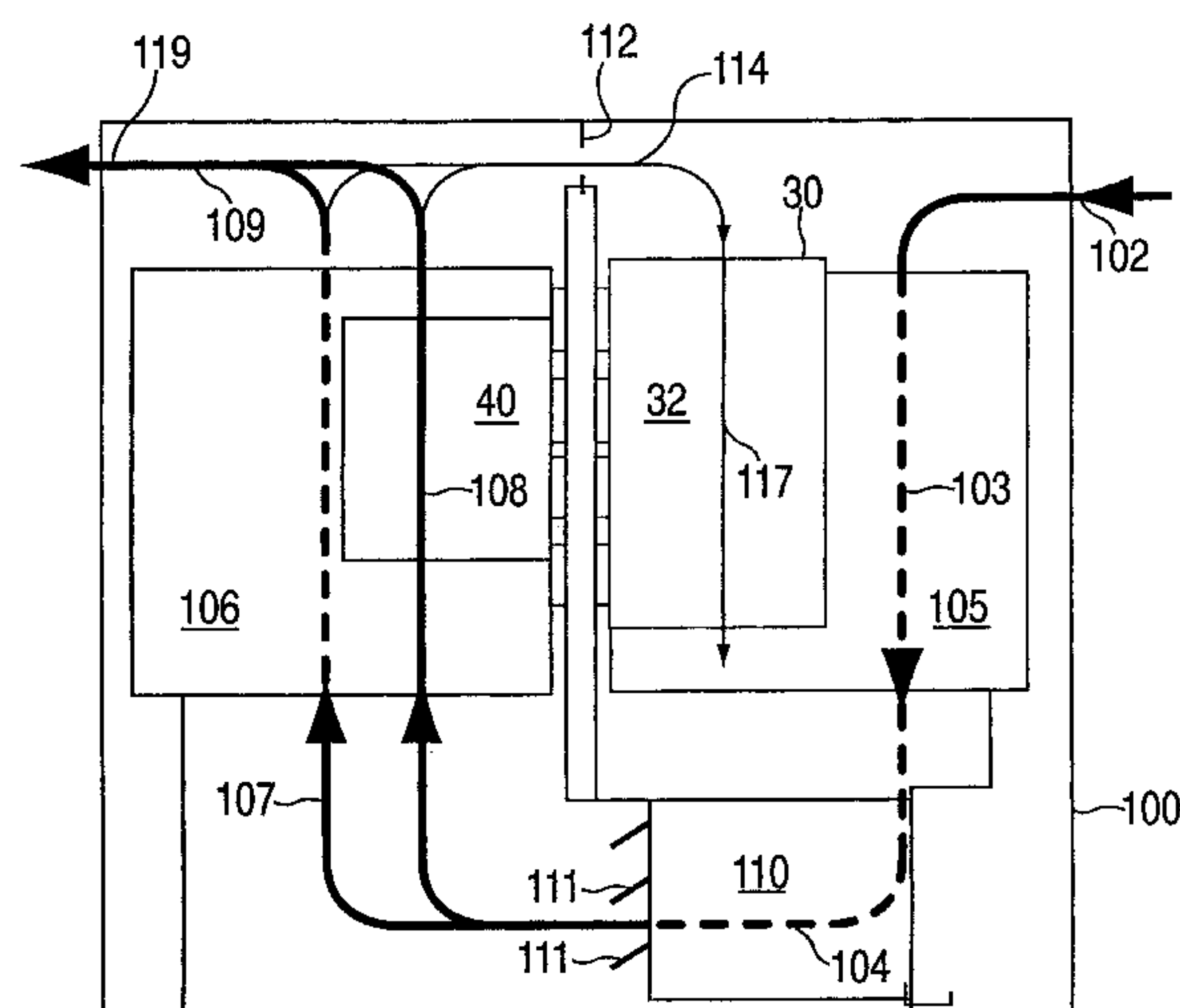
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(57) **ABSTRACT**

A refrigeration system includes an evaporator housing sealed to a first side of a circuit board containing a logic module, the evaporator housing including an evaporator block in thermal communication with the logic module. The evaporator housing further includes at least a humidity sensor for detecting a humidity within the evaporator housing. In another aspect of the invention, the refrigeration system includes a heater on a second side of the circuit board opposite the evaporator housing, the heater being in thermal communication with plated through-holes of the circuit board to maintain the circuit board above local ambient temperature. In another aspect of the invention, a source of dry pressurized air is provided into the sealed evaporator housing through a through-hole drilled directly under the logic module. In another aspect of the invention, a portion of the warm air exiting the processor cage is recirculated and caused to pass over the evaporator housing, thereby ensuring that the exterior surface of the evaporator housing is warming to above local dew point. In another aspect of the invention, two or more modular, interchangeable refrigeration units are concurrently connected to the evaporator and are controlled independently, providing backup capability to ensure the reliability of the system.

1 Claim, 7 Drawing Sheets



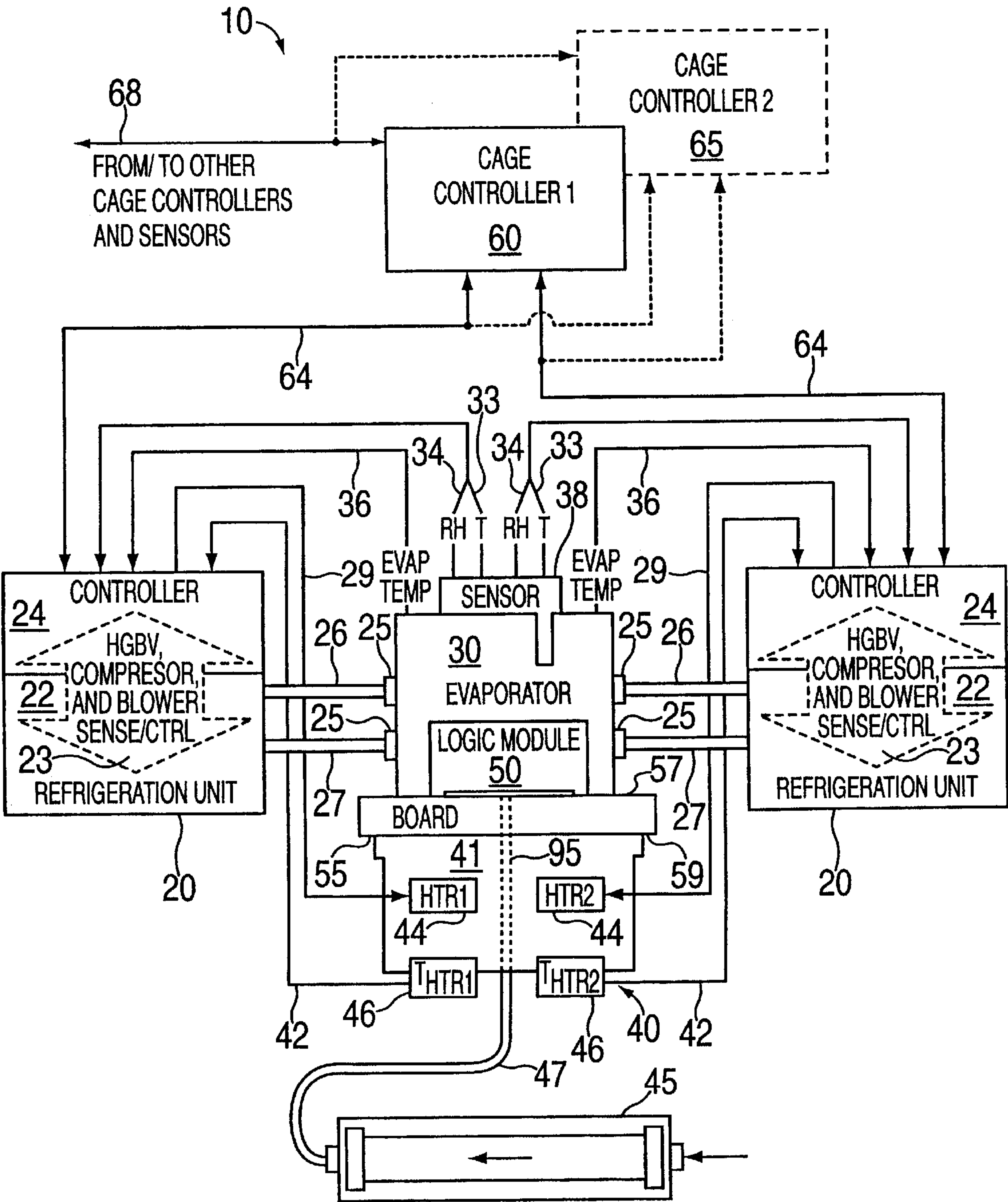


FIG. 1

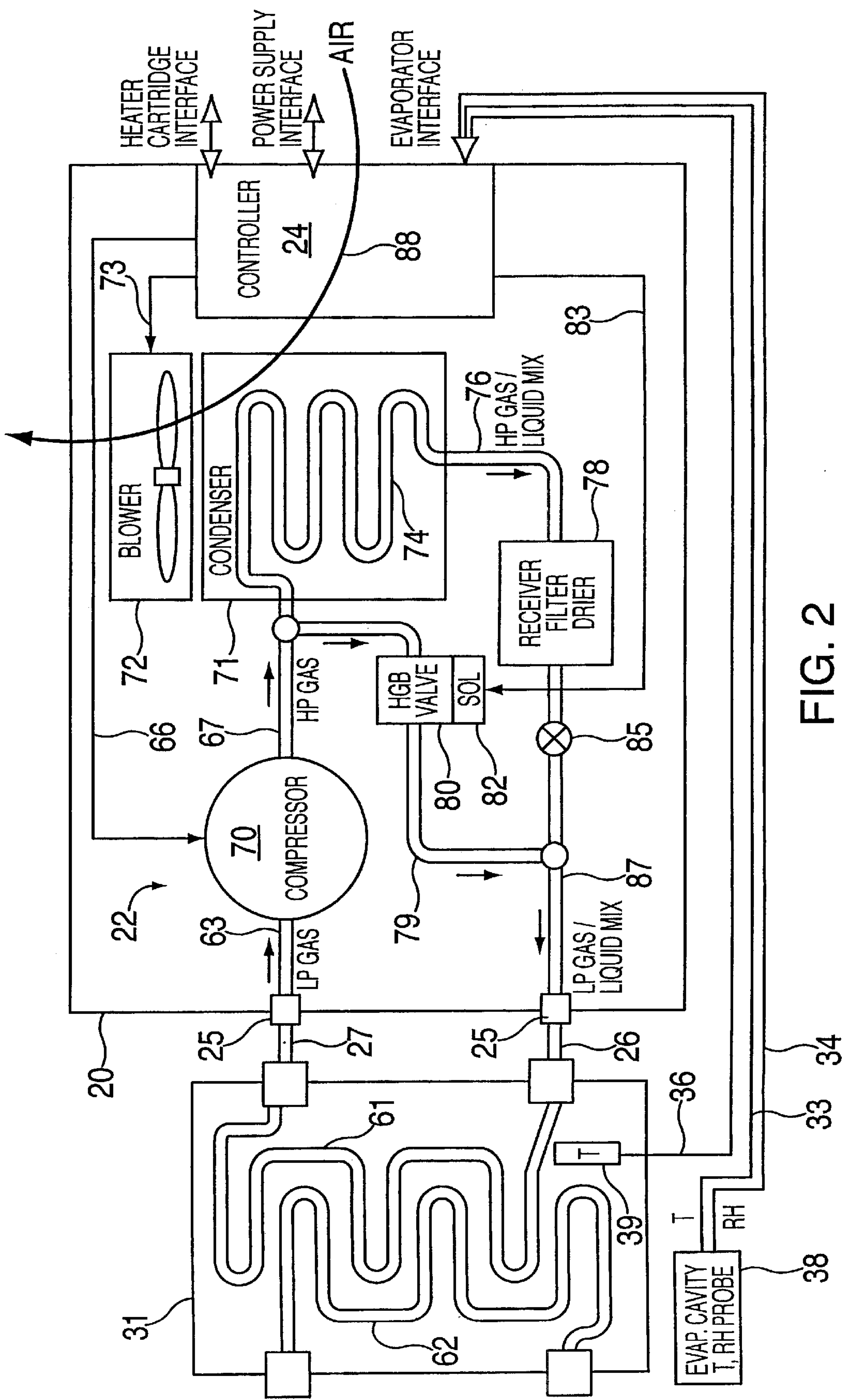


FIG. 2

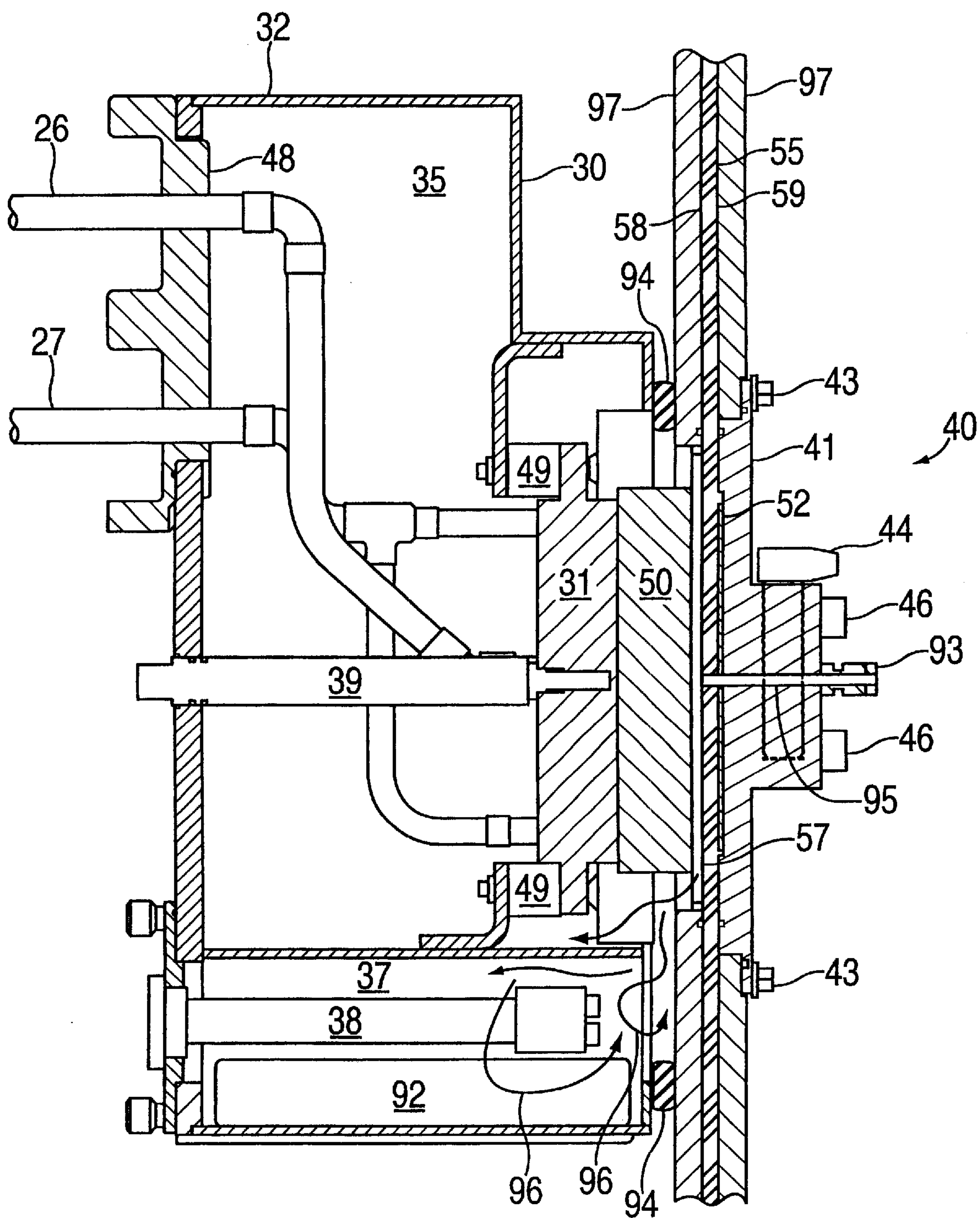
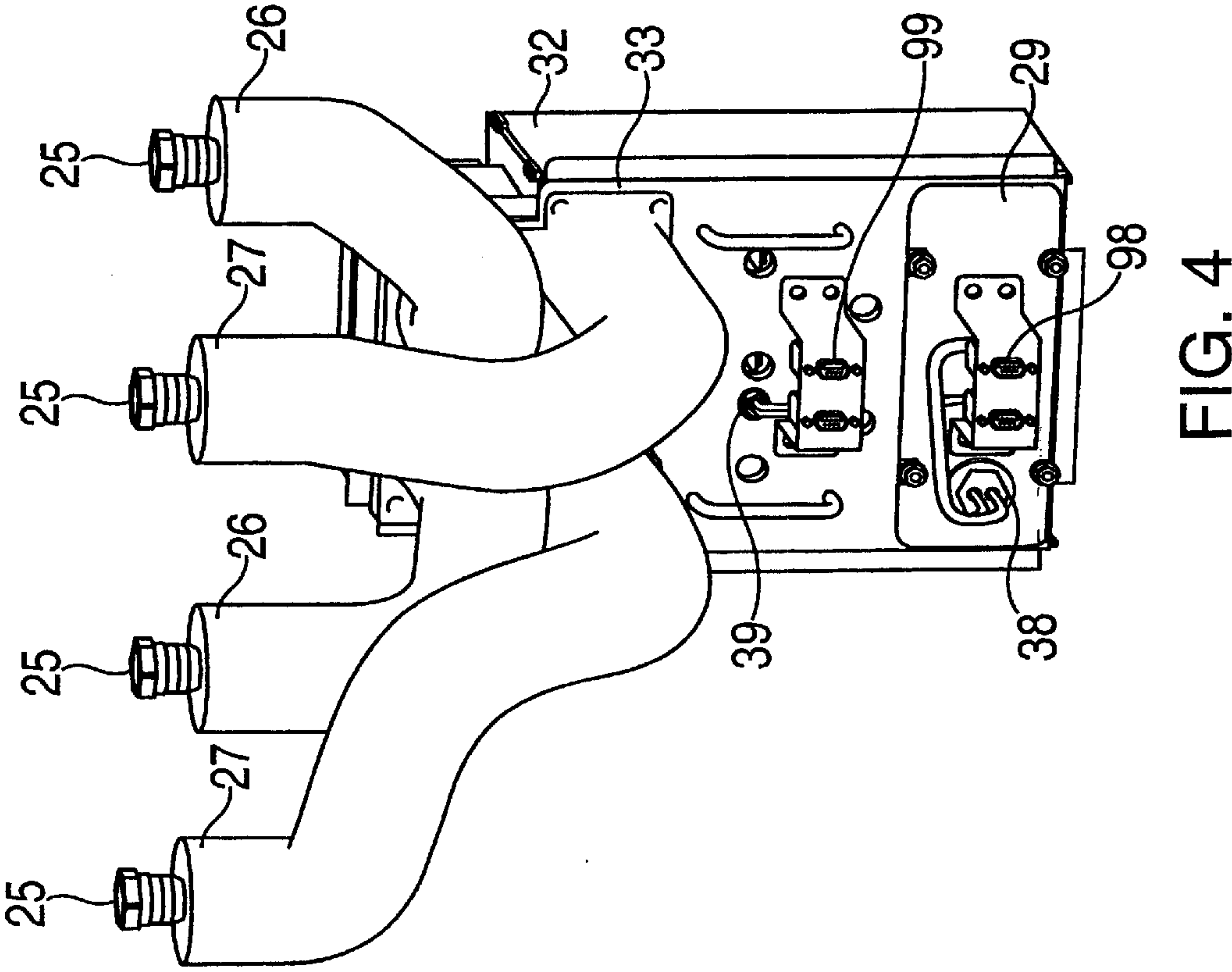
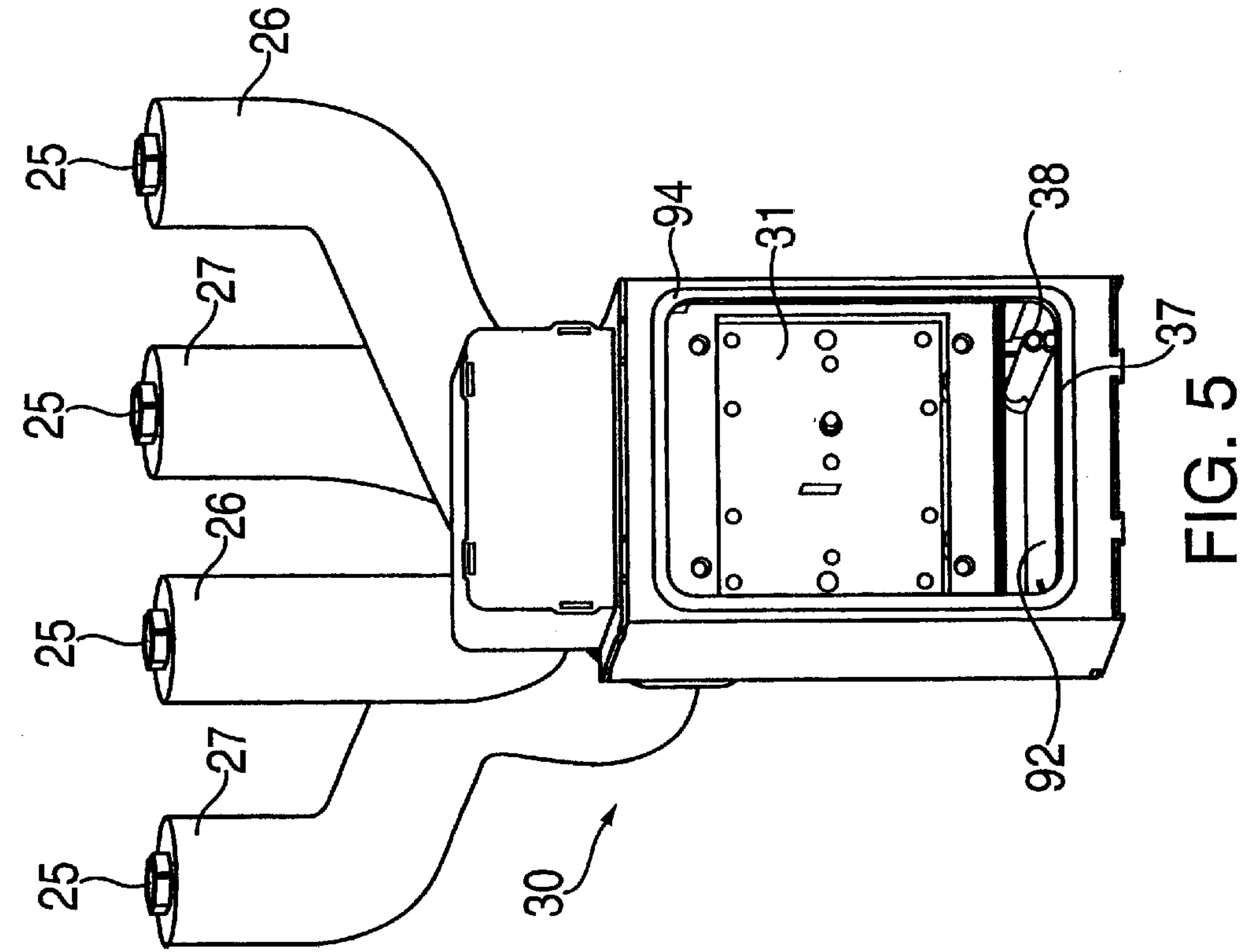


FIG. 3



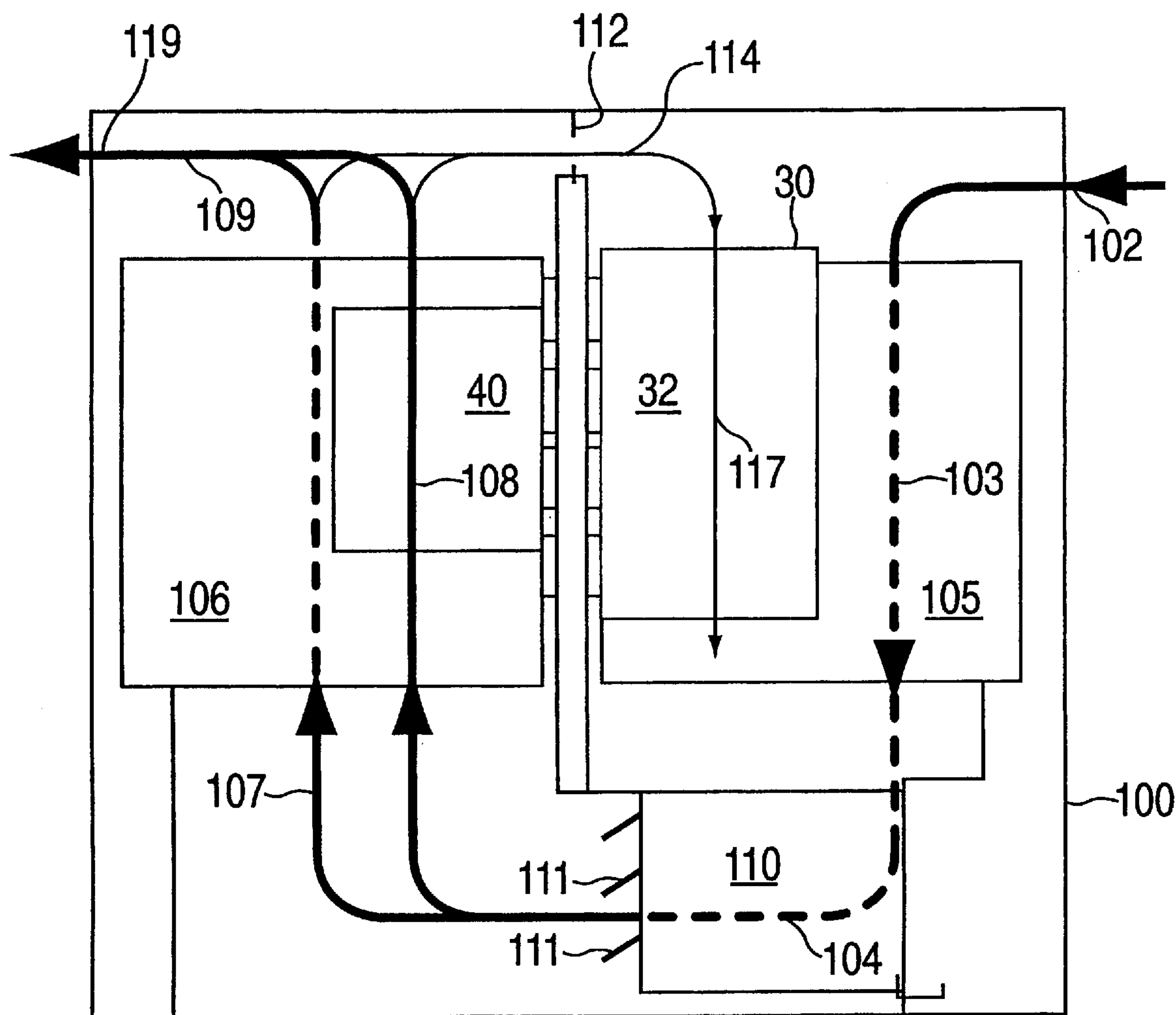
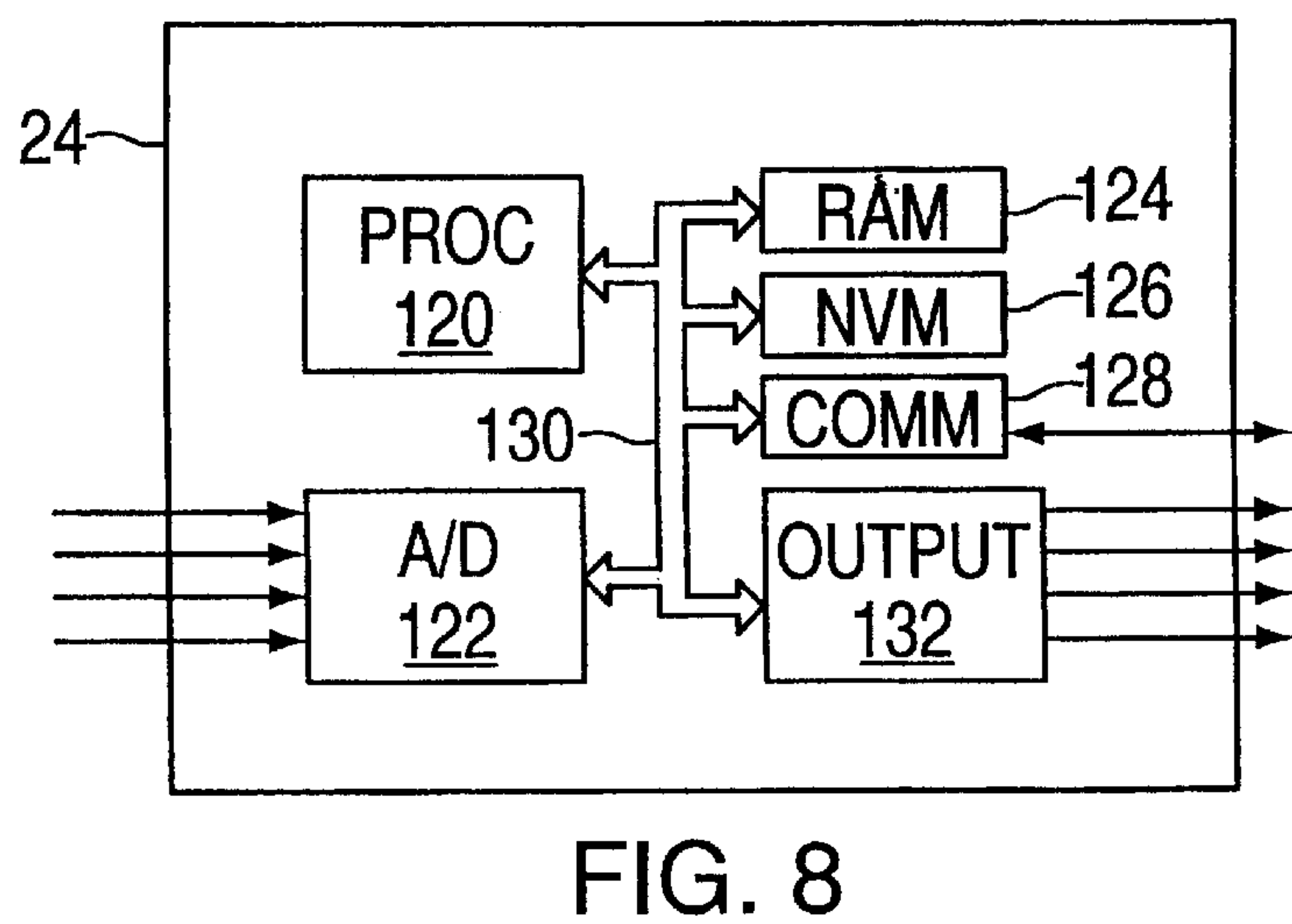
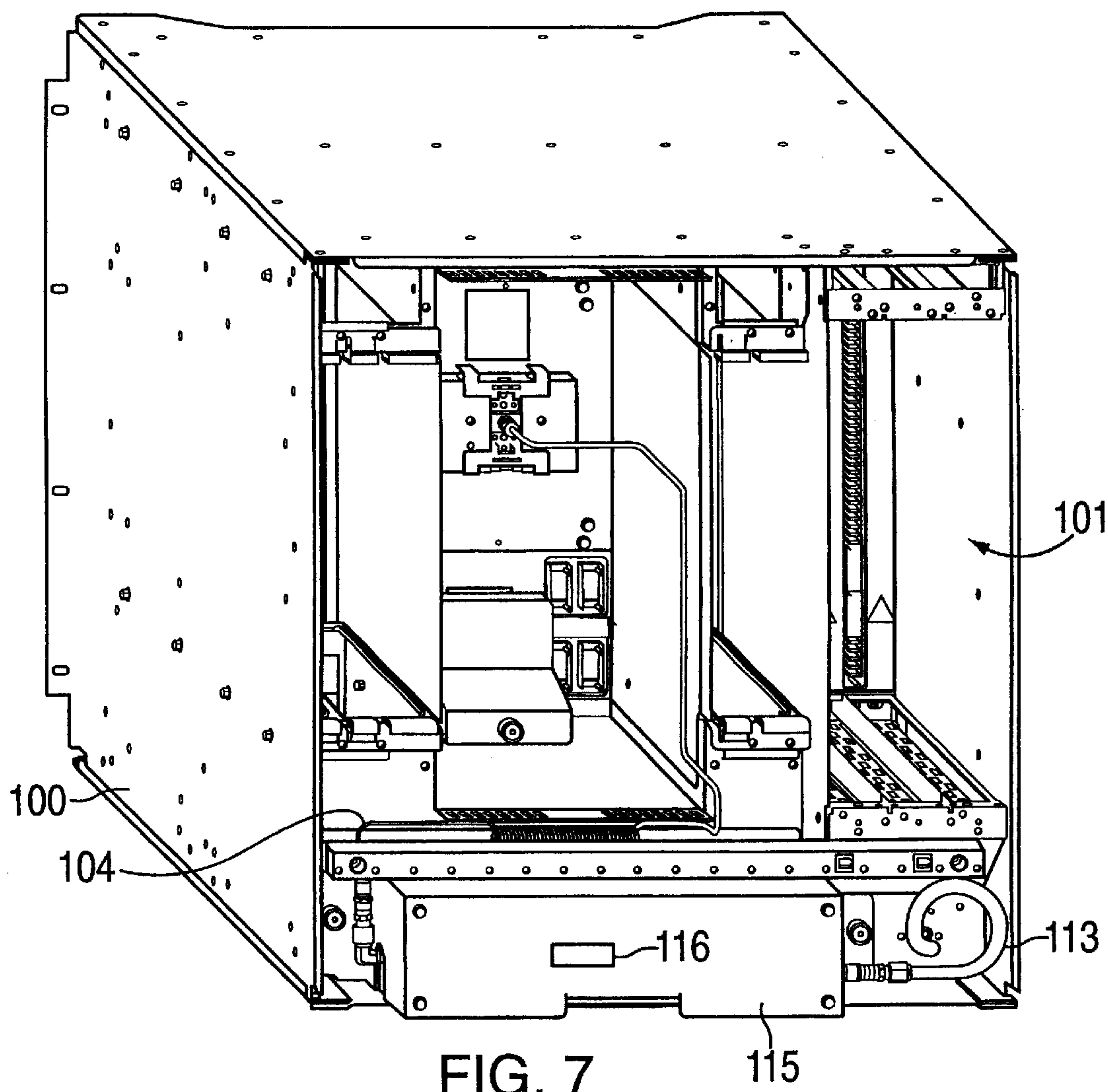
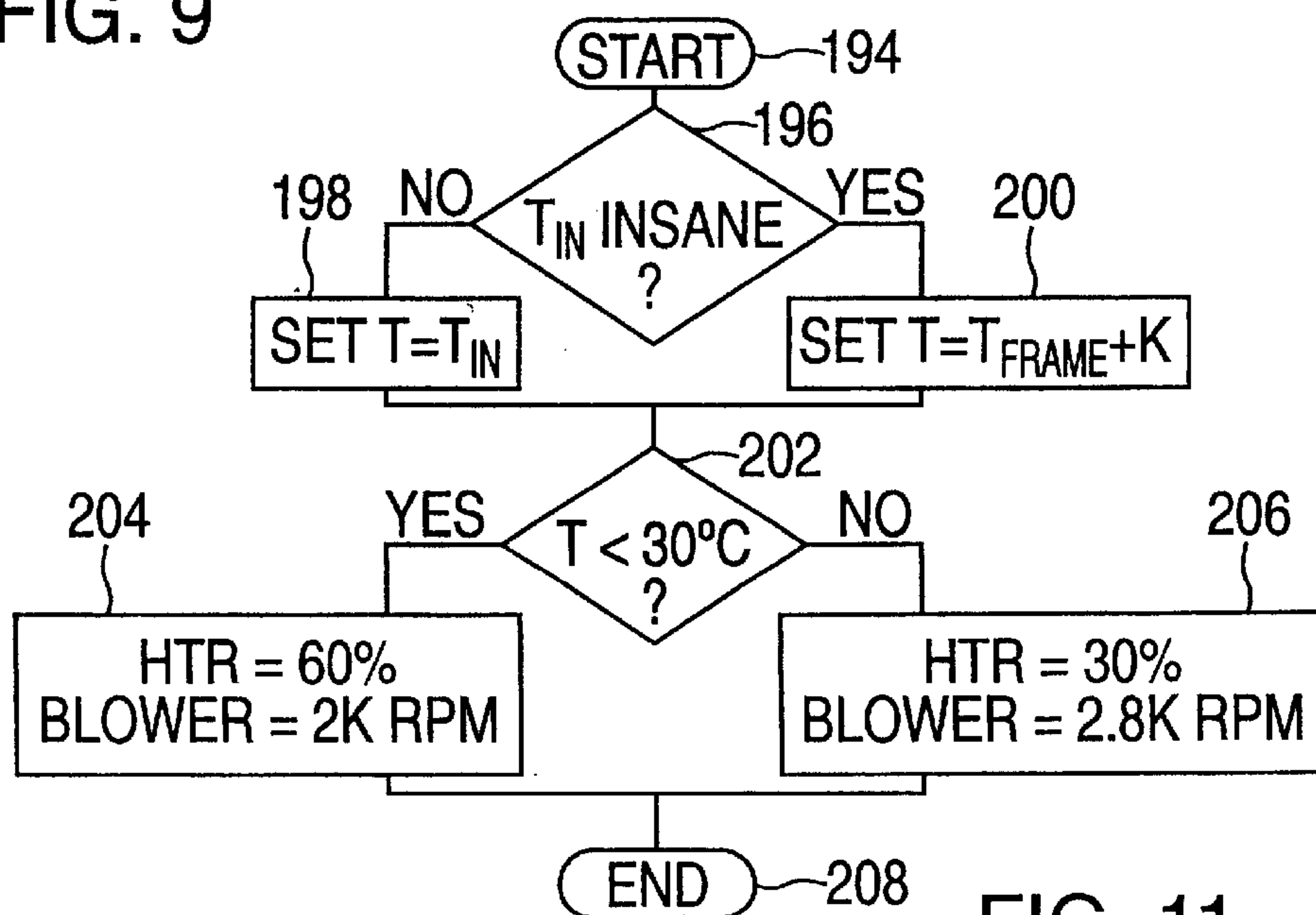
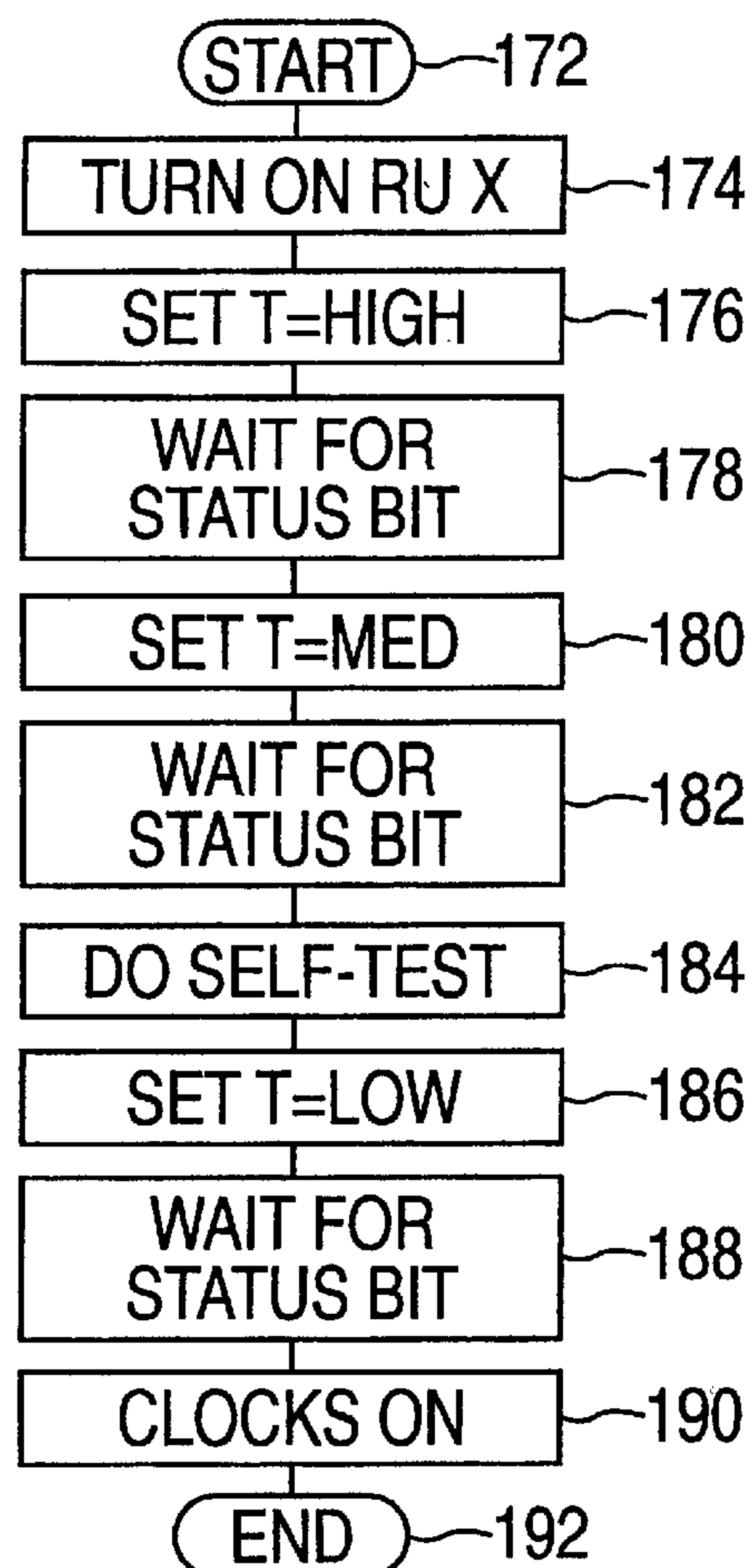
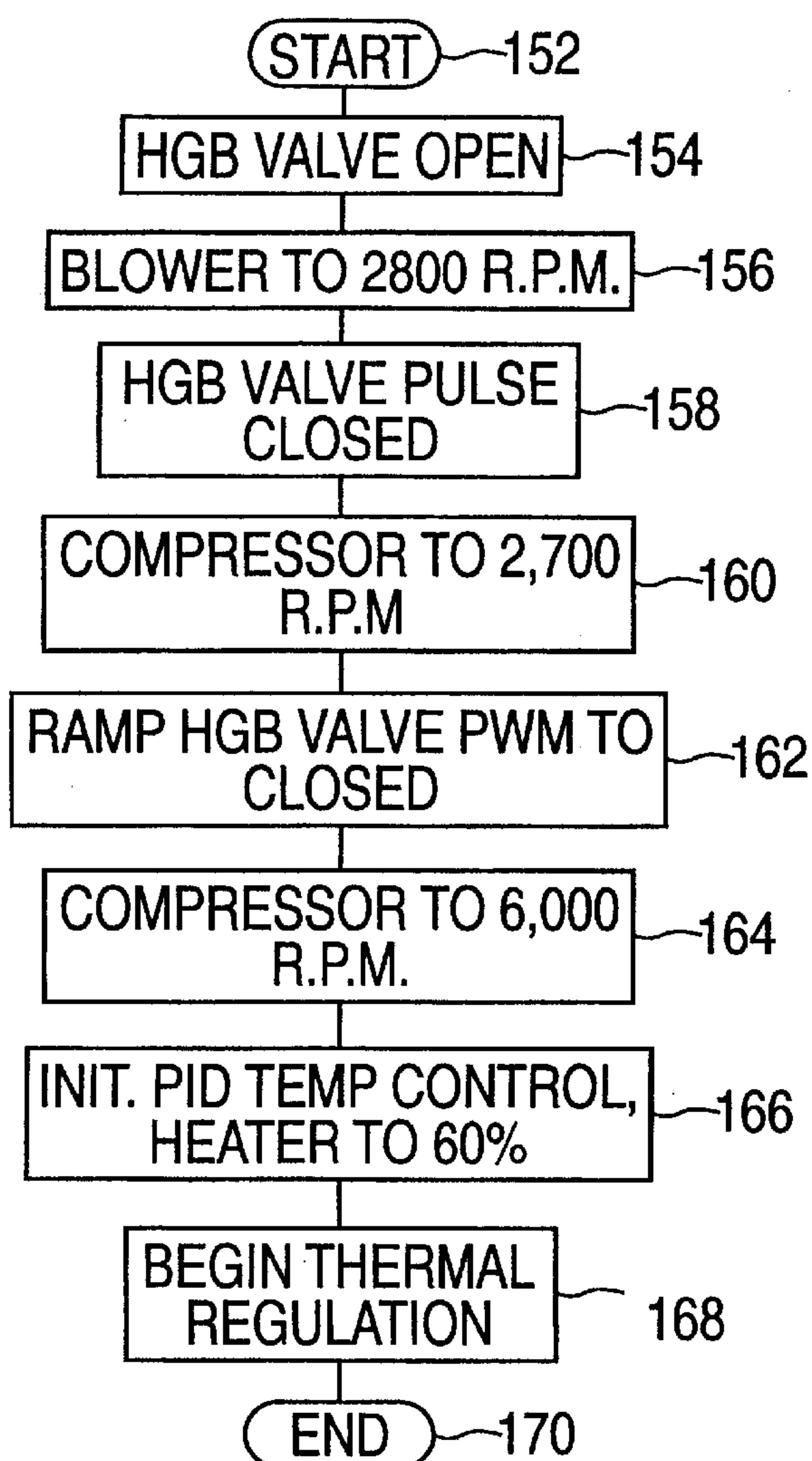


FIG. 6





LOGIC MODULE REFRIGERATION SYSTEM WITH CONDENSATION CONTROL

REFERENCE TO RELATED APPLICATION

This application is a divisional of U.S. patent application Ser. No. 09/896,310, filed Jun. 29, 2001 now U.S. Pat. No. 6,446,447, entitled "Logic Module Refrigeration System with Condensation Control", the entirety of which is hereby incorporated by reference.

BACKGROUND

The present invention relates to a cooling system and condensation control system. In particular, the present invention relates to a cooling system and condensation control system for computer logic modules.

One of the factors that limit processing speed in computer systems is the generation of excessive heat at higher clock speeds. Significant gains of speed and reliability have been achieved by cooling computer logic modules down to temperatures below ambient. Unfortunately, cooling a logic module to below ambient temperatures can result in the formation of condensation, which is undesirable in a computer system.

Prior attempts at providing a cooling system for a computer module have not been satisfactory for higher-end computing applications. For example, one approach has been to remove moisture from incoming air cooled to 5° C. This approach requires handling a tremendous amount of water, and does not prevent condensation in an application where refrigerant may be operating as cold as -40° Celsius. Another approach has been to simply apply a fixed high-power heater around an evaporator unit which surrounds the logic module. In this way, the surface temperature of the logic module housing remains above the dew point. Another approach relies on enclosing the logic module in a vacuum enclosure as a means of providing effective insulation. Unfortunately, these approaches cannot adequately ensure that there will be no condensation in the evaporator housing and are therefore not sufficiently reliable.

Another problem unresolved by prior art cooling systems relates to condensation formed on the opposite side of the circuit board. This problem has limited the temperatures to which the logic module can be cooled to avoid condensation.

SUMMARY

The above discussed and other drawbacks and deficiencies of the prior art are overcome or alleviated by a refrigeration system including an evaporator housing sealed to a first side of a circuit board containing a logic module, the evaporator housing including an evaporator block in thermal communication with the logic module. The evaporator housing further includes at least a humidity sensor for detecting a humidity within the evaporator housing. In another aspect of the invention, the refrigeration system includes a heater on a second side of the circuit board opposite the evaporator housing, the heater being in thermal communication with plated through-holes of the circuit board to maintain the circuit board above local ambient temperature. In another aspect of the invention, a source of dry pressurized air is provided into the sealed evaporator housing through a through-hole drilled directly under the logic module. In another aspect of the invention, a portion of the warm air exiting the processor cage is recirculated and caused to pass over the evaporator housing, thereby ensuring that the exterior surface of the evaporator housing is warming to

above local dew point. In another aspect of the invention two or more modular, interchangeable refrigeration units are concurrently connected to the evaporator and are controlled independently, providing backup capability to ensure the reliability of the system.

BRIEF DESCRIPTION OF THE DRAWINGS

The above-discussed and other features and advantages will be made known from the following detailed description and accompanying drawings, wherein like elements are numbered alike, and in which:

FIG. 1 is a schematic representation of an exemplary embodiment of the hardware components of a refrigeration system;

FIG. 2 is a schematic representation of an exemplary refrigeration unit and evaporator block;

FIG. 3 is a cross-section view of an exemplary installed evaporator and heater;

FIG. 4 is a front perspective view of the evaporator of FIG. 3;

FIG. 5 is a rear perspective view of the evaporator of FIG. 3;

FIG. 6 is a schematic diagram depicting air flow management scheme in a processor cage;

FIG. 7 is a perspective view of an exemplary processor cage;

FIG. 8 schematically represents certain components of a refrigeration unit controller; and

FIGS. 9, 10, and 11 show flow charts representing certain exemplary methods for operating or controlling a refrigeration system.

DETAILED DESCRIPTION

FIG. 1 is a schematic diagram providing an overview of the hardware components of exemplary refrigeration system 10. Refrigeration system 10 includes redundant refrigeration units 20 (two are shown) that sequentially or in unison provide coolant to evaporator 30 via refrigerant lines 26. Although the cooling system will be described with reference to two refrigeration units 20, it will be understood that the invention can be adapted for use with one or more such refrigeration units. Evaporator 30 is disposed over logic module 50 and is in thermal communication therewith for cooling logic module 50 to temperatures below ambient. Heat from logic module 50 is absorbed by coolant in evaporator 30. Coolant is then passed back to refrigeration units 20 where it is compressed, condensed, and expanded in any known refrigeration cycle.

Logic module 50 is preferably a multi-chip module, as are generally known in the art, but cooling system 10 is applicable to other concentrated heat generating devices that are advantageously maintained at below ambient temperatures. Logic module 50 is electrically and mechanically attached to a first side 58 of circuit board 55. Both logic module 50 and circuit board 55 are relatively flat structures having heights that are substantially less than their widths or lengths, and are shown in FIG. 1 in profile view (i.e., disposed perpendicular to the page). To prevent condensation on a second side 59 of circuit board 55 from forming, a heater 40 is disposed on second side 59 of circuit board 55. Heater 40 includes a heat spreader plate 41 in thermal communication with circuit board 55. Thermal pads 52 (FIG. 3) enhance thermal coupling between heat spreader plate 41 and plated through-hole connections (not shown) of circuit board 55,

effectively warming circuit board **55**. Heater **40** further includes redundant heat cartridges **44** to provide heat to heat spreader plate **41**. Each heat cartridge **44** includes a resistive heat element (not shown) for converting electrical energy into heat energy. In a preferred embodiment, each heat cartridge is rated at 300 W. In addition to heat cartridges, other heat source types, such as flat resistive heaters, are contemplated.

Each refrigeration unit **20** includes a respective controller **24** in communication with a primary cage controller **60** and secondary cage controller **65**, the latter being available in case of failure of primary cage controller **60**, via two-way communication lines **64**. Controller **24** operates in response to instructions from primary cage controller **60** or secondary cage controller **65** to cool logic module **50** to a desired temperature. In aid of this objective, controller **24** is equipped with various outputs and inputs to control refrigeration equipment **22** and to monitor the actual temperature of the evaporator. In addition to cooling logic module **50**, controller **24** is responsible for preventing condensation within evaporator **30** and on circuit board **55**, monitoring the temperature and relative humidity in the evaporator cavity (to be described in more detail below) and the temperature of heater **40**, to ensure that it is greater than the dew point within the processor cage (FIGS. 6, 7).

Controller **24** controls refrigeration equipment **22** within refrigeration unit **20** via signal lines **23**, and controls heat cartridge **44** via lines **29**. Evaporator plate temperature is provided via lines **36** and evaporator cavity temperature and relative humidity are provided via lines **33** and **34**, respectively. Finally, lines **42** provide heater temperature feedback.

Refrigeration units **20** are modular in nature, i.e., they are interchangeable and provide redundancy or backup capabilities to evaporator **30**. Refrigerant lines **26** and refrigerant return lines **27** are connected to refrigeration unit **20** via respective quick-disconnect couplings **25** so that either refrigeration unit **20** may be quickly swapped out for maintenance or replacement once another refrigeration unit is on line. Refrigeration units **20** each include a condenser and compressor, as is known in the refrigeration art, and passes pressurized refrigerant, which may exist as a liquid, gas, or mixed-phase fluid to evaporator **30** via refrigerant lines **26**. In a preferred embodiment, the compressor is a Maneurop LT-22 compressor, but any rotary, reciprocating, or scroll compressor of sufficient cooling capacity could be used. The precise refrigeration cycle and working fluid is determined based on a number of factors, such as the desired resultant temperature, environmental/regulatory considerations, desired coefficient of performance, desired size of condenser, cost, etc.

Referring now to FIG. 2, an exemplary cooling cycle using R507 (AZ50) refrigerant provides temperatures as cold as -40°C . and colder. As would be appreciated by those skilled in the art, the target temperature may vary with the compression ratio and other factors, including various control measures as will be hereinafter described.

In the exemplary arrangement shown, a mixture of gas and liquid refrigerant are passed to evaporator block **31** via refrigerant line **26**. Evaporator block **31** comprises copper, aluminum, or other heat conductive material and includes independent serpentine paths **61** and **62** formed therein. Serpentine paths **61** and **62** are circuitous pathways that may be formed by any known method, such as by cutting paths into a center layer that is then sealed between upper and lower layers of the material. Exemplary evaporator block structures are shown and described in commonly assigned

U.S. Pat. No. 5,970,731 to Hare et al, issued Oct. 26, 1999 and U.S. Pat. No. 6,035,655 also to Hare et al., issued Mar. 14, 2000, both of which are herein incorporated by reference. Evaporator block **31** includes an additional serpentine path **62** for connection with a second refrigeration unit **20**. Serpentine paths **61** and **62** are separated and are not in fluid communication with each other so that one refrigeration unit **20** may be disconnected while the other continues to operate. Evaporator block **31** is disposed in thermal communication with logic module **50** within evaporator **30** (FIGS. 1, 3) so that heat from logic module **50** is readily absorbed by refrigerant in serpentine paths **61** and **62**.

Upon absorbing heat from logic module **50** (FIG. 1) the refrigerant vaporizes and is passed back to refrigeration unit **20** via refrigerant return line **27**. This gaseous refrigerant is passed to compressor **70** via line **63**, compressed therein, and then passed to condenser **71** via line **67**, wherein it is condensed back into a liquid or mixed phase fluid. Blower **72** is driven by a variable A.C. motor or D.C. motor and pulls air through electronic controller **24** and condenser **71** in a path generally represented by arrow **88** for absorbing the heat from the refrigerant.

After being condensed in condenser **71**, the coolant is received in filter/drier tank **78** via line **76**, then passed to expansion valve **85** where a portion of the coolant is vaporized and its temperature is reduced. The coolant is then once again made available to evaporator **30** via line **87**. A bypass line **79** is provided between lines **67** and **87** for bypassing the condenser and expansion valve in order to moderate the coolant's temperature. Bypass line **79** includes hot gas bypass valve **80**, actuated by solenoid **82**.

Controller **24** includes a processor and memory, as will be further described, for executing machine code to control the operation of refrigeration unit **20**. Control unit **24** includes various inputs for temperature and humidity sensors in evaporator **30**, to be described in more detail below, and outputs to control compressor **70**, bypass valve **80**, and blower **72** via lines **66**, **83**, and **73**, respectively. Any of lines **66**, **83**, and **73** may carry control signals for actuating a relay or motor controller (not shown) which switches on and off power to the respective component, or such relay/motor controller may be internal to controller **24**, and lines **66**, **73**, and **83** carry power to the respective components, in the known manner. The power supply and power lines are not illustrated for sake of clarity.

Additionally, refrigeration unit **20** includes outputs for controlling heat cartridge **44** (FIGS. 1, 3) and an input for receiving electrical power for supplying energy to controller **24**, as well as compressor **51**, blower **61**, and solenoid **82**.

FIG. 3 shows a cross section view of an exemplary implementation of an evaporator **30** and heater **40** assembled with a logic module **50** and circuit board **55**. Circuit board **55** is provided with stiffeners **97** on either side to aid in supporting and attaching evaporator **30** and heater **40** to circuit board **55**. Evaporator **30** is attached to a first side **58** of circuit board **55** and heater **40** is attached to a second side of circuit board **55** by screws **43** connected to stiffener **97** as shown. Refrigerant line **26** and refrigerant return line **27** supplies one of two serpentine paths **61** and **62** (FIG. 2). A second pair of refrigerant and refrigerant return lines lie directly behind lines **26** and **27** shown, allowing connection to an additional refrigeration unit **20**, as described above.

Refrigerant line **26** and refrigerant return line **27** are connected to evaporator block **31** which is in thermal communication with logic module **50**. Evaporator block and logic module **50** are sealed in an evaporator housing **32** by

gasket **94**. After assembly, Evaporator cavity **35** is filled with insulation, such as an injected polymer foam insulation, to reduce the amount of heat absorbed from evaporator housing **32**, thus preventing the temperature of evaporator housing **32** from dropping below dew point. Grommet **48** is formed of insulating material and includes holes for passing refrigerant lines **26** and refrigerant return lines **27** into evaporator housing **32**. Also extending into housing **32** is evaporator block temperature probe **39**, which includes a sensor extending into evaporator block **31** for detecting the temperature of the evaporator block, and providing feedback information to refrigeration units **20** as previously described. Evaporator block temperature probe **39** preferably comprises dual thermistors for providing independent temperature detection for each of two refrigeration units **20**. Evaporator housing **32** is attached to circuit board **55** in the known manner, with evaporator block **31** being biased against logic module **50** using biasing elements **49**, which may comprise metal springs or elastomeric blocks.

Heater **40** comprises heat spreader plate **41** which includes accommodations for two heat cartridges **44** and dual temperature sensors **46** for detecting the temperature of heat spreader plate **41** and providing feedback to respective refrigeration units **20**.

The internal atmosphere of evaporator **30** will be described with reference now to FIGS. **1** and **3**. Desiccant canister **45** is connected at its inlet to a source of pressurized air. Dry air flows out of desiccant canister **45** through capillary tube **47** to heat spreader plate **41**. Heat spreader plate **41** and circuit board **55** include an aligned through-hole **95** for conducting dry air from said capillary tube to the first side **58** of circuit board **55**. Logic module **50** comprises a zero-insertion force connector as is known in the art which includes a small air space **57** (FIG. **3**) between logic module **50** and circuit board **55**. This arrangement raises the air pressure in evaporator housing **32** to slightly above ambient. Thus, any small amount of leakage or diffusion will only result in dry air infiltrating into evaporator housing **32**.

Evaporator **30** also includes a desiccant slot **37** housing a desiccant bag **92** which absorbs any remaining moisture in evaporator cavity **35**, such as might occur upon replacement or servicing of dual humidity and temperature sensor **38**. Arrows **96** shows free movement of air between evaporator cavity **35** and desiccant slot **37**. Desiccant slot **37** also houses dual humidity and temperature sensor **38**, which includes redundant humidity and temperatures sensors. In a preferred embodiment, humidity and temperature sensor is or is similar to one available from Honeywell, part number H1H-3602-C and includes two independent humidity sensors and two independent thermistors. Capillary tube **47** is sufficiently long or otherwise includes an airflow resistor, such as an orifice, to prevent excessive air flow through capillary tube **47** in the case of a leak or while dual humidity and temperature sensor **38** is being serviced or replaced.

FIGS. **4** and **5** show front and rear perspective views of evaporator **30**, respectively. Refrigerant lines **26** and refrigerant return lines **27** are surrounded with thermal insulation to prevent condensation and loss of efficiency. Desiccant slot cover **28** (FIG. **4**) encloses desiccant slot **37** and supports "D" connectors **98** which connect dual humidity and temperature sensor **38** to respective refrigeration units **20**. Similarly, "D" connectors **99** are provided to connect evaporator block temperature sensor **39** to respective refrigeration units **20**.

FIG. **6** shows a schematic representation of airflow management within processor cage **100**. Air is drawn into

processor cage **100** at air inlet **102**. Air flows past memory books **105** and redundant power supplies (not shown) along path **103**. Air is then forced through one of a plurality of blowers **110** (only one shown). Blower **110** includes louvers **111** which operate as check valves to prevent back flow through blower **110** when fewer than all blowers are operating. Air flows generally along path **107** by memory books **106** and along path **108** by heater **40**. A majority of this air exits at exit **119**, however some air flows through orifice **112** and then past evaporator **30** and then recirculates through one or more of blowers **110**. In this manner, evaporator housing **32** is warmed by air previously warmed by absorbing heat from the power supply (not shown), memory books **105**, **106**, blowers **110**, and heater **40**. This warmed air passes heat energy to evaporator housing **32**, thereby increasing its surface temperature to above dew point, ensuring that no condensation will form thereon.

FIG. **7** shows a perspective view of cage controller **100**. A source of pressurized air supplies air through air hose **113** to desiccant canister **45** (FIG. **1**) which resides in canister housing **115**. A view-window **116** is provided so that an operator can see when the desiccant changes color, indicating saturation. Canister housing **115** outputs dry air to capillary tube **104** which is sufficiently long to restrict the air flow as previously described. Capillary tube **104** feeds into heat spreader plate **41** as shown. Cavity **101** receives modular redundant power supplies which provide power to logic module **50** (FIG. **1**).

Referring to FIG. **8**, each refrigeration unit controller **24** includes a processor **120**, an analog-to-digital converter **122**, random access memory **124**, non-volatile memory **126**, communication port **128**, and output **132**. Controller **24** also includes other necessary ancillary components such as power supply, clock, etc., which are not shown for sake of clarity. Non-volatile memory **126** may be any type of machine readable media such as ROM, PROM, EPROM, EEPROM, Flash, magnetic media, optical media, or other known type of non-volatile memory. Communications port **128** is preferably a standard serial port, as are generally known in the industry, such as the RS422 serial port. Each of these components are in communication with processor **120** via one or more data busses **130** (only one shown).

During operation of controller **24**, software stored in non-volatile memory **126** causes processor **120** to perform various operations on input and to generate outputs accordingly. As shown in FIG. **1**, controllers **24** are in communication with primary and secondary cage controllers **60** and **65**. Additionally, cage controllers **60** and **65**, which are also intelligent devices, are in communication with other controllers and sensors via Ethernet (see line **68** in FIG. **1**) as generally known and understood in the art. Cage controllers **60** and **65** are responsible for monitoring and regulating the power supply, cooling fans, internal processor cage temperature, and other environmental aspects of the processor cage to ensure proper functioning of the system and the various internal components.

The use of an intelligent refrigeration unit controller allows the refrigeration unit to cooperate with the cage controller and larger system to maximize the performance of the logic module without sacrificing reliability. In this regard the controller can, in response to instructions from cage controller **60**, precisely control the temperature of the evaporation block by controlling the speed of compressor **70** and by actuating hot gas bypass valve **80** (FIG. **2**) in response to temperature readings from evaporator block temperature probe **39**. The temperature to which the evaporator block is controlled may vary according to the current condition or

operation of the logic module operating mode or power consumption, as well as the expected condition or operation of the logic module. In addition, the refrigeration unit controller is capable of reacting to component failures and notifying the cage controller of such failures. This provides improved reliability by allowing the cage controller to then switch to a second refrigeration unit and alert system administrators of the failure for repair or replacement of the defective component and/or refrigeration unit. Furthermore, by integrating the refrigeration unit with the cage controller, smooth transitions from one refrigeration unit to another can be easily achieved.

SYSTEM	RU 1	RU 2
N mode	On	Off
N + 1 mode	On	Deactivated
Switchover mode	Switchover-from	Switchover-to

The system and the individual refrigeration units are capable of entering several different modes of operation to accomplish this task as summarized by Table 1. These modes will now be described with reference to an exemplary system capable of being connected to only two refrigeration units at any one time, though it should be understood that the system may be adapted to accommodate any number of refrigeration units. In the “N-mode,” one refrigeration unit is on while the other refrigeration unit is either off or deactivated. When in the off-mode, the refrigeration unit is not operating to cool the logic module, but it is actively communicating with cage controller 60. When in the deactivated-mode, the refrigeration unit is off-line or disconnected. In the N+1 mode, the first refrigeration unit is on, while the second is “enabled”. In the enabled mode, a refrigeration unit is not functioning to cool the logic module, and it is in communication with cage controller 60. What distinguishes “enabled” from “off” is that when enabled, the refrigeration unit is ready to step in and turn on, by itself and without instruction from the cage controller, if necessary. The conditions under which an enabled refrigeration unit may turn on by itself include sensing evaporator over-temperature and the cage controller didn’t turn it on. A third mode of the system is the “switchover” mode. In a switchover mode, one refrigeration unit is designated the “switchover-from” unit, indicating that it is in a shut-down sequence, and one refrigeration unit is in a “switchover-to” mode, indicating that it is in a start-up sequence. The shutdown and startup sequences vary depending on whether the switchover-from unit is experiencing a fatal error or whether the switchover-from unit is running normally or experiencing only a minor error. A minor error is one that can be compensated, an example of which will be described below with reference to FIG. 11.

Each controller 24 makes status data available to the cage controller 60, and the cage controller 60 periodically transmits status data and instructions to the refrigeration unit controllers 24. This periodic data transmission is called “stuffage” and allows the refrigeration units to react to failures of the cage controllers, while the cage controllers’ monitoring of refrigeration unit data allows them to react to failures of the refrigeration units in a logical manner. In the exemplary embodiment, refrigeration unit controller 24 sends posts the value of all the sensors of the refrigeration unit, particularly the evaporator and heater block temperatures, flags indicating the mode the refrigeration unit

is currently in, and fault data, such as evaporator cavity over-humidity, heater block over-temperature, etc. This information is available to the cage controller to read. Every 7 seconds or so, the cage controller 60 stuffs the refrigeration unit with data including the current power of the logic module, ambient temperature, control commands such as turn on/off, prepare for power on, prepare for self test, enter enable mode, enter/exit switch-over-to mode, enter/exit switch-over-from mode, fault flags control commands to set or clear fault flags in the refrigeration unit controller.

During operation, cage controller 60 determines the set point for the refrigeration units. The set point is the desired temperature of evaporator block, and is dependent on the requirements of the logic module and the mode of operation and power draw of the logic module. For example, during start up operation, the set point is initially set to a high temperature of, e.g., 0° C. which may be designated a standby temperature. During self-test or periods of low current draw, the set point is set to an intermediate temperature to avoid condensation, e.g., -10° C. During normal operation, the set point is set to a low temperature, e.g., -20° C. It may be necessary to raise the set point during periods of low power dissipation in the logic module to ensure the surface temperature of the portion of the circuit board outside the sealed environment does not rise above the dew point.

FIG. 9 provides a flow chart diagram describing an exemplary start-up sequence. This represents code in refrigeration unit controller 24 and is particularly directed towards starting up the compressor without drawing excessive current from the power supply. The procedure begins at start block 152 and proceeds immediately to block 154 which instructs the hot gas bypass valve 80 (FIG. 2) to open to unload the compressor. Compressor 70 (FIG. 2) is driven to a relatively slow speed of about 2700 r.p.m. The hot gas bypass valve 80 is then pulsed by opening, closing, then opening again, to ensure that it is functioning properly. By employing pulse width modulation, the hot gas bypass valve is ramped to 100% closed at block 162. At about 81 seconds from start-up, the compressor speed is advanced to 50 Hz, which is equivalent to 3000 rpm at block 164. In block 166 PID (proportional, integral, derivative) control of the evaporator block temperature then begins at about 86 seconds after startup and the heater is powered to 60% on (e.g., using pulse width modulation with about 2 second cycle time). Block 168 begins thermal regulation and at block 170, the logic thread terminates.

The cage controller prepares for changes in logic state and sets the set point prior to the change, but not for so long as to create condensation. For example, in order for the logic module to function at optimum cycle time, it should already be chilled to its planned temperature condition. Therefore, the logic code must first request a low temperature state, then wait for the cage controller and refrigeration unit to provide that state, e.g., by changing the set point. Once the set point is achieved, the refrigeration unit sets a status bit for the cage controller to read, thus indicating that it has achieved status. The status bit may be indicative of an evaporator block temperature being within a selected range, e.g., 2° C. or 5° C., of the set point. Once the cage controller notices that the status bit is set, it gives permission to the logic code to operate at the faster cycle time. If the cage controller or refrigeration unit notices that the logic module failed to increase its cycle time within a selected time frame, e.g., anywhere from 20 seconds to 2 minutes, it will reset the set point to the high or medium temperature, to avoid condensation.

FIG. 10 represents code in cage controller 60 that is executed prior to “clocks-on” mode, i.e., prior to running logic module at its optimum speed. This procedure begins with block 172 and proceeds immediately to block 174 wherein one of refrigeration units 20 is turned on. The unit to be turned on may be selected at random, or otherwise. At block 176, the set point temperature T is initially set to high, which may correspond to 0° C. At block 178, cage controller 60 then waits for the status bit in refrigeration unit 20 as described above. If all is well, cage controller 60 sets the set point to a medium value, e.g., -10° C. as block 180 provides. At block 182, cage controller 60 then waits once again for the status bit in refrigeration unit 20. At block 184, with the logic module cooled to its intermediate value, cage controller 60 signals higher-level code to commence its self test. This step may be skipped at the user’s option. If all is well, cage controller continues to block 186 where the set point is finally set to the low temperature, e.g., -20° C. At block 188, cage controller 60 again waits for the status bit. Then, at block 190, cage controller gives the higher-level code the go-ahead for clocks-on, and the procedure terminates at block 192. If clocks-on fails to commence within a selected time-frame, e.g., 2 minutes, then the set point is returned to the intermediate value to prevent over-cooling of the circuit board.

Each refrigeration unit controller 24 monitors its individual humidity sensor or its independent output of dual humidity and temperature sensor 38 to ensure that it remains within normal limits. If the sensor output is outside the normal limits of the sensor probe, controller 24 sets an error flag indicating that the sensor is “insane”. Higher level system code monitors the error flags from refrigerator unit 20. Upon detecting the error, the higher level system code will message a system operator that the humidity sensor needs to be replaced, as described below.

Sometimes, a humidity sensor will slowly drift from the correct reading, rather than returning an insane value. To detect a faulty sensor that is merely inaccurate, rather than insane, cage controller 60 compares the actual sensor values together when one of refrigeration units 20 indicates an over humidity condition. If the difference between the readings is beyond a miscompare limit, e.g., 5% relative humidity, the higher-reading humidity sensor is flagged as defective and the operator is requested to replace the dual humidity and temperature sensor 38. If the difference between the readings is within the miscompare limit, then a dry air breach warning is surfaced and a repair is requested of this condition. In an alternate embodiment, dual humidity and temperature sensor 38 is replaced with a pressure sensor. This would protect against failures of the seal around evaporator cavity 35, but would not insure against moisture diffusion through the various elastomeric membranes.

It should be noted that the output of the thermistors in dual humidity and temperature sensor 38 are used to correct the sensed relative humidity value for evaporator cavity 35 in accordance with the manufacturer’s specifications. It is this temperature-corrected relative humidity value that is used for fault detection and isolation. The correction is required since the local air temperature around dual humidity and temperature sensor 38 varies with ambient as well as with the temperature set point in evaporator 30.

Concurrent maintenance, i.e., maintenance during continued operation of the logic module, of the dual humidity and temperature sensor 38 (humidity sensor) is accomplished by deactivating the humidity sensor. In this case, “deactivating” the humidity sensor means causing heat cartridge 44 to thermostatically control the board temperature to a higher

than normal value to prevent moisture from forming thereon when evaporator cavity 35 is opened for the short time needed to replace humidity sensor 38. Refrigeration unit controller 24 sets a timer when the humidity sensor is deactivated and gives a warning signal if the repair procedure takes too long. For example, if the evaporator cavity is opened for more than 10 minutes, an audible alarm is produced, or a warning message is sent to cage controller 60. If the amount of dry air supplied from desiccant canister 45 is increased while evaporator cavity 35 is opened, then this time may be increased. For example, capillary tube 47 may be replaced with a pair of differently-sized orifices, with a valve and actuating mechanism, to allow increased air flow while the humidity sensor is being serviced.

While dual humidity and temperature sensor 38 is being replaced, the internal desiccant bag is also replaced so that any moisture that enters evaporator cavity 35 during this procedure is removed. Once dual humidity and temperature sensor 38 is replaced, it is “activated” and the heaters are returned to normal power. Refrigeration unit 20 then resumes normal monitoring of the relative humidity levels in evaporator cavity 35.

Temperature sensors 46 are monitored for sanity in a manner similar to the way the humidity sensors are monitored. For example, if the heaters are more than 10° C. apart in their temperature measurements, a miscompare fault flag is set, and one or both sensors are replaced.

Outputs of temperature sensors 46 are also compared with over and under temperature limits. These limits are a function of other system states or environmental conditions. A temperature outside the range defined by the over and under limits, could indicate a faulty heater, connection, or drive circuit. A defect in the running refrigeration unit triggers a switchover to the other (good) refrigeration unit. The defective heat cartridge and thermistor is concurrently replaced by first deactivating the heater, causing the good running refrigeration unit to thermostatically control the heater to a lower, touchable temperature. As with the humidity sensor, a timer is set as a result of the heater deactivating command. Sufficient time is allotted for replacing heat cartridge 44 and thermistor 46, but not so much time as to permit moisture to form on critical surfaces. For example, the timer may be set for 10 minutes, after which an alarm sounds.

Each refrigeration unit 20 controls its own heat cartridge 44, and the heat value is controlled from no heat to full heat, up to 300 W, if heat cartridge 44 is a 300 W heater. Heat cartridge 44 is controlled by pulse width modulation at a frequency fast enough compared to the thermal mass of heat cartridge 44 that prevents temperature cycling and related heater failure, e.g., 2 Hz has been found to be a sufficiently fast frequency. Unique heat values are used for particular power and environmental states. In a method described by FIG. 11, the heater power is reduced for high ambient air temperature conditions. Ambient temperature is measured within the refrigeration unit enclosure at the inlet to condenser 71 (FIG. 2) using a thermistor. This thermistor is tested for sanity in the same manner as temperature sensor 46 described above. Starting with block 194 refrigeration unit controller 24 proceeds immediately to block 196 and determines whether the thermistor at the inlet of condenser 71 is insane. If not, controller 24 proceeds to block 198 wherein the condenser inlet temperature is taken as the ambient temperature, and controller 24 proceeds to block 202. If the thermistor is insane, then the ambient temperature is set to the ambient temperature from a thermistor mounted on the system frame, which is provided in stuffage from cage controller 60. A compensation value is added to this value

since the frame temperature will typically be several degrees cooler than the air entering condenser 71, due to the environment in refrigeration unit 20. Controller 24 then proceeds to block 202.

At block 202, controller 24 tests whether the ambient temperature is less than 30° C. If so, heat cartridge 44 is set to 60% of maximum and blower 72 (FIG. 2) is set to 2,000 rpm. Then, the procedure terminates at block 208. If the ambient temperature is greater than 30° C., the heat cartridge is set to only 30% of maximum and the blower is set to 2,800 rpm, to compensate for warmer ambient air.

Switchover from one refrigeration unit 20 to another refrigeration unit 20 can occur on a scheduled basis, for example, every 160 hours. In addition, switchover can be for recovery purposes, i.e., when one refrigeration unit is faulty. In particular, a recovery switchover may be in response to such failures as double communications fault to the on refrigeration unit, temperature sensor 46 insane, over temperature, or under temperature, or dual humidity and temperature sensor insane or over humidity. A double communication fault occurs when both cage controller 60 and secondary cage controller 65 lose communication with the on refrigeration unit.

In a switch-over mode, cage controller 60 posts switching-from and switching-to bits in stuffage to respective refrigeration units 20, then posts a “switchover” function bit. The switching-from refrigeration unit compressor is set to maximum speed and its hot gas bypass valve is closed (0%) to prepare for turning on the switching-to refrigeration unit. After a short pause, the switching-to refrigeration unit is turned on, causing significant heat to be passed to evaporator block 31 during startup. The switching-to unit set point is then set a small amount lower (e.g., 1° C.) than the set point of the switching-from refrigeration unit, causing the switching-to unit to be taxed to a greater extent as the switching-from unit dumps heat through its hot gas bypass valve in an effort to bring the temperature up to its set point. Switching-to and switching-from refrigeration units are designed to be capable of maintaining this “switch-over” mode indefinitely. However, the switching-from refrigeration unit is kept on for a selected period of time, e.g., 4 minutes. The switching-from refrigeration unit is then turned off only after the switching-to unit exhibits no fault or warning conditions. After good status, the cage controller shuts down the switching-from refrigeration unit, and places it in enabled mode, then clears the switchover mode and function bit.

In the case of a recovery switchover, there is no pause in bringing the switching-to refrigeration unit to the set point temperature, and once achieved, the switching from refrigeration unit is immediately shut down.

When a system is powered off after the logic module has been chilled to below zero, there is a danger that condensation will form when the evaporator is removed to service the logic module. To prevent such condensation from forming, cage controller 60 sends the running refrigeration unit 20 a “prepare-for-power-off” command, causing it to open its hot gas bypass valve 80, causing high enthalpy refrigerant to pass directly into the evaporator and thus rapidly heating the evaporator, as well as the logic module it is attached to. To further accelerate the heating of the chilled logic unit and circuit board, heat cartridge 44 is left on. These steps enable logic module 50 to be serviced in an acceptable timeframe without danger of condensation being formed on the vulnerable areas.

While the invention has been described with reference to specific embodiments thereof, it is intended that all matter contained in the above description and shown in the accompanying drawings be interpreted as illustrative and not limiting in nature. Various modifications of the disclosed embodiments, as well as other embodiments of the invention, will be apparent to those skilled in the art upon reference to this description, or may be made without departing from the spirit and scope of the invention as defined in the appended claims.

We claim:

1. A refrigeration and condensation control system for cooling a logic module mounted to a first side of a circuit board, the system comprising:
 - a processor cage housing the circuit board;
 - an evaporator housing installed over the logic module, the evaporator housing being sealed to the circuit board;
 - a blower for circulating air within the processor cage, said air drawing cool air from outside the processor cage through an air inlet and expel warmed air out of the cage through an outlet; and
 - an air passageway connecting flows upstream and downstream of the blower, the evaporator housing being positioned in said air passageway so that a portion of said warmed air is recirculated to pass over the evaporator housing for warming the exterior surface of the evaporator housing to above the local dew point.

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